



3A SURFACE MOUNT GLASS PASSIVATED BRIDGE RECTIFIER

Product Summary (@T_A = +25°C)

Description and Applications

and telecommunication applications.

V _{RRM} (V)	I _O (A)	V _F (V)	Ι _R (μΑ)
1,000	3	1.0	5

Suitable for AC to DC bridge full wave rectification for SMPS, LED lighting, adapter, battery charger, home appliances, office equipment,

Features and Benefits

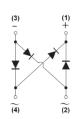
- Glass Passivated Die Construction
- Miniature Package Saves Space on PC Boards
- Low Leakage Current
- Ideal for SMT Manufacturing
- Low Forward Voltage Drop
- Surge Overload Rating to 110A Peak
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: DBF
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (e3)
- Polarity: As Marked on Body
- Weight: 0.214 grams (Approximate)



Top View



Internal Schematic

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DBF310-13	Commercial	DBF	3,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information

Notes:



DBF310 = Product Type Marking Code) !!= Manufacturers' Code Marking YM = Date Code Marking Y = Last Digit of Year (ex: 7 = 2017)

- M = See Month/Code Table Below
- D = Day 1~9 =1~9; Day 10~31= A~V

Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	1,000	V
RMS Reverse Voltage	V _{R(RMS)}	700	V
Average Rectified Output Current (Note 5) @ T _C = +120°C	lo	3.0	А
Non-Repetitive Peak Forward Surge Current, 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	110	А
I ² t Rating for Fusing (1ms < t < 8.3ms)	l ² t	50.2	A ² S

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Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance, Junction to Ambient (Note 6) (Per Element)	R _{0JA}	15	°C/W
Typical Thermal Resistance, Junction to Case (Per Element)	R _{θJC}	5	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	V _{(BR)R}	1,000	_	_	V	I _R = 5μA
Forward Voltage (Per Element)	VF		0.88 0.93	0.95 1.0	V	I _F = 1.5A, T _A = +25°C I _F = 3A, T _A = +25°C
Leakage Current (Note 7) (Per Element)	I _R	_	0.07 25	5 500	μA	V _R = 1,000V, T _A = +25°C V _R = 1,000V, T _A = +125°C
Total Capacitance (Per Element)	CT	—	35	_	pF	V _R = 4V, f = 1.0MHz

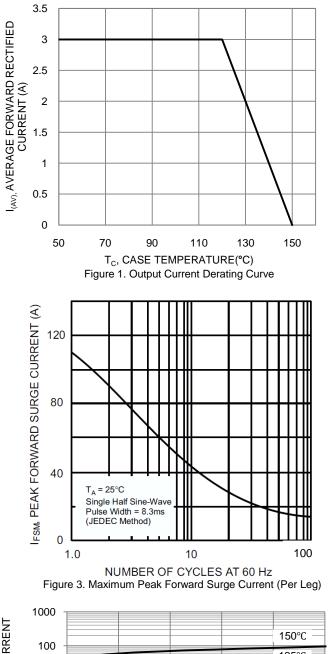
Notes:

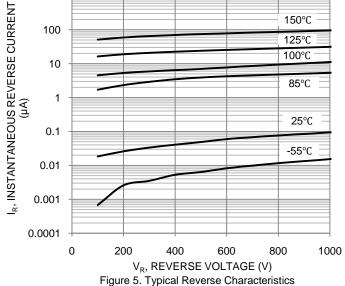
Device mounted on glass epoxy PC board with 1.3mm² solder pad.
Device mounted on glass epoxy substrate with 1oz/ft², 15mmx15mm copper pad per pin.
Short duration pulse test used to minimize self-heating effect.

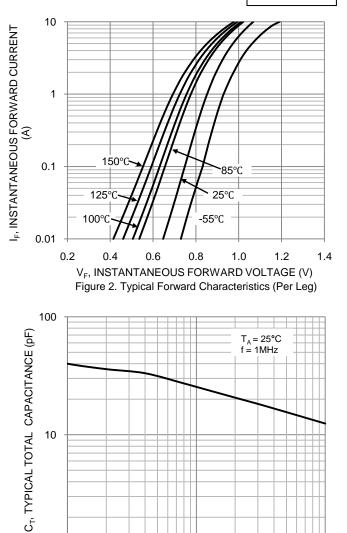


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DBF310







10 V_R, REVERSE VOLTAGE (V) 100 Figure 4. Typical Total Capacitance (Per Leg)

10

1

1

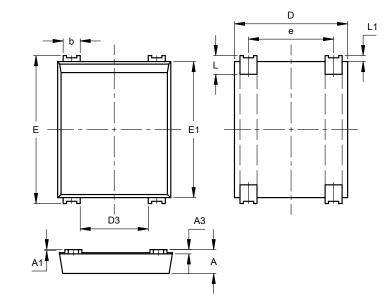


Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

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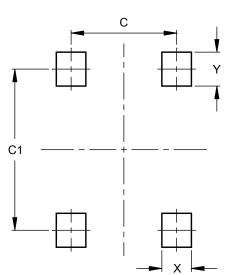




1							
DBF							
Dim	Min	Max	Тур				
Α	1.30	1.50					
A1	0.04	0.12					
A3	0.15	0.35					
b	0.80	1.20					
D	6.45	6.85					
D3	3.80	4.20					
ш	8.50	8.90					
E1	7.80	8.20					
е	4.80	5.20					
L	0.80	1.40					
L1	0.30	0.40					
All	All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	5.00
C1	7.60
Х	1.40
Y	1.60

DBF



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